

### **Amendments to the Claims**

This listing of claims will replace the originally filed claims in the application.

#### **Listing of Claims:**

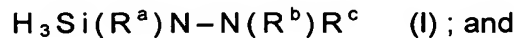
Claims 1 – 17 (canceled).

Claim 18 (new): A method which may be used for producing a silicon nitride film by vapor-phase growth, wherein said method comprises:

- a) feeding a first hydrazine gas and at least one precursor gas into a reaction chamber, wherein:
  - 1) said precursor gas comprises at least one member selected from the group consisting of:
    - i) trisilylamine gas; and
    - ii) silylhydrazine gas; and
  - 2) at least one substrate is located in said reaction chamber; and
- b) forming a silicon nitride film on said substrate by reacting said first hydrazine gas and said precursor gas.

Claim 19 (new): The method of claim 18, wherein:

- a) said silylhydrazine is defined by formula (I)



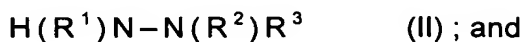
- b)  $\text{R}^a$ ,  $\text{R}^b$ , and  $\text{R}^c$  each comprise at least one member selected from the group consisting of:
  - 1) silyl;
  - 2) hydrogen;
  - 3) methyl;
  - 4) ethyl; and
  - 5) phenyl.

Claim 20 (new): The method of claim 18, further comprising:

- a) creating said precursor gas in a synthesis chamber by reacting a silylamine gas with a second hydrazine gas to form a silylhydrazine gas; and
- b) feeding said precursor gas into said reaction chamber from said synthesis chamber.

Claim 21 (new): The method of claim 18, wherein:

- a) said first hydrazine gas is defined by formula (II)

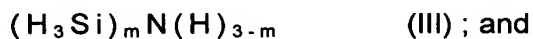


- b)  $\text{R}^1$ ,  $\text{R}^2$ , and  $\text{R}^3$  each comprise at least one member selected from the group consisting of:

- 1) hydrogen;
- 2) methyl;
- 3) ethyl; and
- 4) phenyl.

Claim 22 (new): The method of claim 20, wherein:

- a) said silylamine is defined by formula (III)



- b)  $m$  is 1, 2, or 3.

Claim 23 (new): The method of claim 20, wherein:

- a) said second hydrazine is defined by formula (IV)



- b)  $\text{R}^x$ ,  $\text{R}^y$ , and  $\text{R}^z$  each comprise at least one member selected from the group consisting of:

- 1) hydrogen;
- 2) methyl;
- 3) ethyl; and
- 4) phenyl.

Claim 24 (new): The method of claim 18, wherein the temperature of the reaction between said precursor gas and said first hydrazine gas is between about 300°C and about 700°C.

Claim 25 (new): The method of claim 18, wherein the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr.

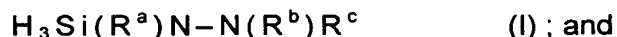
Claim 26 (new): The method of claim 18, further comprising feeding an inert dilution gas into said reaction chamber.

Claim 27 (new): A method which may be used for producing silicon nitride films by vapor-phase growth, said method comprising:

- a) feeding a silylhydrazine gas into a reaction chamber, wherein said chamber contains at least one substrate; and
- b) forming a silicon nitride film on said substrate by a decomposition of said silylhydrazine gas.

Claim 28 (new): The method of claim 27, wherein:

- a) said silylhydrazine is defined by formula (I)



- b)  $\text{R}^a$ ,  $\text{R}^b$ , and  $\text{R}^c$  each comprise at least one member selected from the group consisting of:
  - 1) silyl;
  - 2) hydrogen;
  - 3) methyl;
  - 4) ethyl; and
  - 5) phenyl.

Claim 29 (new): The method of claim 27, further comprising

- a) creating a silylhydrazine-containing reaction mixture in a synthesis chamber by reacting a silylamine gas with a hydrazine gas; and
- b) feeding said silylhydrazine-containing reaction mixture into said reaction chamber.

Claim 30 (new): The method of claim 29, wherein:

- a) said hydrazine is defined by formula (IV)

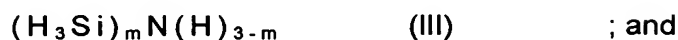


- b)  $\text{R}^x$ ,  $\text{R}^y$ , and  $\text{R}^z$  each comprise at least one member selected from the group consisting of:
  - 1) hydrogen;

- 2) methyl;
- 3) ethyl; and
- 4) phenyl.

Claim 31 (new): The method of claim 29, wherein:

- a) said silylamine is defined by formula (III)



- b) m is 1, 2, or 3.

Claim 32 (new): The method of claim 27, wherein the decomposition of said silylhydrazine gas is carried out at a temperature between about 300° C and about 700°C.

Claim 33 (new): The method of claim 27, wherein the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr.

Claim 34 (new): The method of claim 27, further comprising feeding an inert dilution gas into said reaction chamber.

Claim 35 (new): A method which may be used for producing a silicon nitride film by vapor-phase growth, wherein said method comprises:

- a) feeding a first hydrazine gas and at least one precursor gas into a reaction chamber, wherein:
  - 1) said precursor gas comprises at least one member selected from the group consisting of:
    - i) trisilylamine gas; and
    - ii) silylhydrazine gas;
  - 2) at least one substrate is located in said reaction chamber; and
  - 3) the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr; and
- b) feeding an inert dilution gas into said reaction chamber; and
- c) forming a silicon nitride film on said substrate by reacting said first hydrazine gas and said precursor gas, wherein the temperature of the reaction is between about 300°C and about 700°C.